

2-Input AND Gate with Open Drain Output

NLV74VHC1G09

The NLV74VHC1G09 is an advanced high speed CMOS 2-input AND gate with open drain output fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

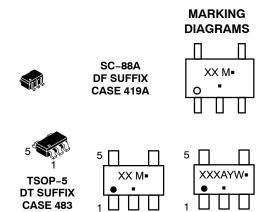
The input structures provide protection when voltages up to 5.5 V are applied, regardless of the supply voltage. This allows the device to be used to interface 5 V circuits to 3 V circuits. Some output structures also provide protection when V_{CC} = 0 V and when the output voltage exceeds $V_{CC}.$ These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

Features

- Designed for 2.0 V to 5.5 V V_{CC} Operation
- 4.3 ns t_{PD} at 5 V (typ)
- Inputs/Outputs Over-Voltage Tolerant up to 5.5 V
- IOFF Supports Partial Power Down Protection
- Source/Sink 8 mA at 3.0 V
- Available in SC-88A and TSOP-5 Packages
- Chip Complexity < 100 FETs
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



Figure 1. Logic Symbol



XX = Specific Device Code

M = Date Code*= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

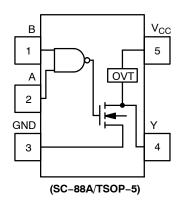


Figure 2. Pinout (Top View)

PIN ASSIGNMENT

(SC-88A/TSOP-5)

Pin	Function
1	В
2	Α
3	GND
4	Y
5	V _{CC}

FUNCTION TABLE

Inp	Output	
Α	В	Υ
L	L	L
L	Н	L
Н	L	L
Н	Н	Z

MAXIMUM RATINGS

Symbol	c	Value	Unit		
V _{CC}	DC Supply Voltage	-0.5 to +7.0	V		
V _{IN}	DC Input Voltage	-0.5 to +7.0	V		
V _{OUT}	DC Output Voltage	1Gxx		-0.5 to V _{CC} + 0.5	V
		1GTxx	Active-Mode (High or Low State) Tri-State Mode (Note 1) Power-Down Mode (V _{CC} = 0 V)	-0.5 to V _{CC} + 0.5 -0.5 to +7.0 -0.5 to +7.0	
I _{IK}	DC Input Diode Current	•	V _{IN} < GND	-20	mA
I _{OK}	DC Output Diode Current	1Gxx	V _{OUT} > V _{CC} , V _{OUT} < GND	±20	mA
		1GTxx	V _{OUT} < GND	-20	
I _{OUT}	DC Output Source/Sink Current		±25	mA	
I _{CC} or I _{GND}	DC Supply Current per Supply Pi	±50	mA		
T _{STG}	Storage Temperature Range			-65 to +150	°C
TL	Lead Temperature, 1 mm from Ca	ase for 10 s	ecs	260	°C
TJ	Junction Temperature Under Bias	3		+150	°C
$\theta_{\sf JA}$	Thermal Resistance (Note 2)		SC-88A	377	°C/W
P_{D}	Power Dissipation in Still Air		SC-88A	332	mW
MSL	Moisture Sensitivity	Level 1	-		
F _R	Flammability Rating Oxygen Index: 28 to 34			UL 94 V-0 @ 0.125 in	-
V _{ESD}	ESD Withstand Voltage (Note 3)		Human Body Model Charged Device Model	2000 1000	V
I _{Latchup}	Latchup Performance (Note 4)			± 100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Applicable to devices with outputs that may be tri-stated.
- Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.
 HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to
- HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.
- 4. Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

Symbol	CI	Min	Max	Unit	
V _{CC}	Positive DC Supply Voltage		2.0	5.5	٧
V_{IN}	DC Input Voltage			5.5	V
V _{OUT}	DC Output Voltage	1Gxx	0	V _{CC}	V
		1GTxx Active–Mode (High or Low State) Tri–State Mode (Note 1) Power–Down Mode (V _{CC} = 0 V)	0 0 0	V _{CC} 5.5 5.5	
T _A	Operating Temperature Range	-55	+125	°C	
t _r , t _f	Input Rise and Fall Time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	0 0	100 20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS (MC74VHC1G09)

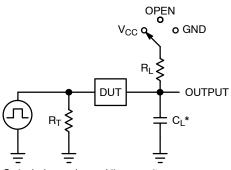
		Test	V _{CC}	1	Γ _A = 25°	С	-40°C ≤	Γ _A ≤ 85°C	-55°C ≤ T	A ≤ 125°C	
Symbol	Parameter	Conditions	(V)	Min	Тур	Max	Min	Max	Min	Max	Unit
V _{IH}	High-Level Input		2.0	1.5	_	-	1.5	_	1.5	-	V
	Voltage		3.0	2.1	-	-	2.1	-	2.1	-	
			4.5	3.15	_	-	3.15	_	3.15	-]
			5.5	3.85	_	-	3.85	_	3.85	-]
V_{IL}	Low-Level Input		2.0	-	-	0.5	-	0.5	-	0.5	V
	Voltage		3.0	-	-	0.9	-	0.9	-	0.9]
			4.5	-	-	1.35	-	1.35	-	1.35]
			5.5	-	-	1.65	-	1.65	-	1.65]
V _{OL}	Low-Level Output Voltage	$\begin{aligned} &V_{IN} = V_{IH} \text{ or } V_{IL} \\ &I_{OL} = 50 \mu\text{A} \\ &I_{OL} = 50 \mu\text{A} \\ &I_{OL} = 50 \mu\text{A} \\ &I_{OL} = 4 \text{ mA} \\ &I_{OL} = 8 \text{ mA} \end{aligned}$	2.0 3.0 4.5 3.0 4.5	- - - -	0.0 0.0 0.0 - -	0.1 0.1 0.1 0.36 0.36	- - - -	0.1 0.1 0.1 0.44 0.44	- - - -	0.1 0.1 0.1 0.52 0.52	>
I _{IN}	Input Leakage Current	V _{IN} = 5.5 V or GND	2.0 to 5.5	_	_	±0.1	-	±1.0	_	±1.0	μΑ
l _{OZ}	3-State Output Leakage Current	V _{OUT} = 0 V to 5.5 V	5.5	-	_	±0.25	-	±2.5	-	± 2.5	μΑ
l _{OFF}	Power Off Leakage Current	V _{IN} = 5.5 V	0.0	_	_	1.0	-	10	_	10	μΑ
Icc	Quiescent Supply Current	V _{IN} = V _{CC} or GND	5.5	_	_	1.0	-	20	_	40	μΑ

AC ELECTRICAL CHARACTERISTICS

				Т	A = 25°	С	-40°C ≤ 1	Γ _A ≤ 85°C	-55°C ≤ T	A ≤ 125°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Тур	Max	Min	Max	Min	Max	Unit
t _{PZL}	Propagation Delay,	C _L = 15 pF	3.0 to 3.6	-	6.2	8.8	-	10.5	-	12.5	ns
	(A or B) to Y (Figures 3 and 4)	C _L = 50 pF		_	8.7	12.3	-	14.0	-	16.5	
		C _L = 15 pF	4.5 to 5.5	-	4.3	5.9	-	7.0	_	9.0	
		C _L = 50 pF		_	5.8	7.9	-	9.0	-	11.0	
t _{PLZ}	Propagation Delay,	C _L = 15 pF	3.0 to 3.6	-	6.5	9.7	-	11.5	_	14.5	ns
	(A or B) to Y (Figures 3 and 4)	C _L = 50 pF		_	8.7	12.3	-	14.0	_	16.5	
		C _L = 15 pF	4.5 to 5.5	-	4.8	6.8	-	8.0	-	10.0	
		C _L = 50 pF		_	5.8	7.9	-	9.0	_	11.0	
C _{IN}	Input Capacitance			-	4.0	10	-	10	-	10	pF
C _{OUT}	Output Capacitance	Output in High Impedance State		-	6.0	-	-	-	-	-	pF

		Typical @ 25°C, V _{CC} = 5.0 V	
C _{PD}	Power Dissipation Capacitance (Note 5)	8.0	pF

^{5.} C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no–load dynamic power consumption; P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.



Test	Switch Position	C _L , pF	R_L , Ω
t _{PLH} / t _{PHL}	Open	See AC Characteristics Table	Х
t _{PLZ} / t _{PZL}	V _{CC}		1 k
t _{PHZ} / t _{PZH}	GND		1 k

X = Don't Care

 C_L includes probe and jig capacitance R_T is Z_{OUT} of pulse generator (typically 50 $\Omega)$ f = 1 MHz

Figure 3. Test Circuit

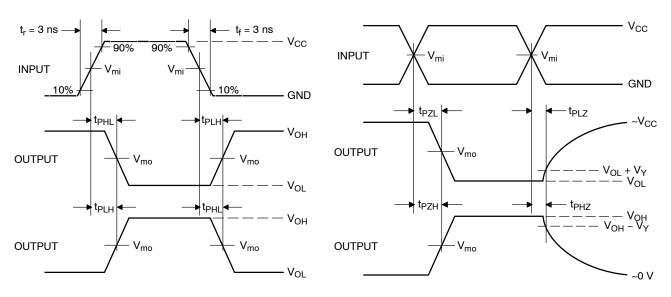


Figure 4. Switching Waveforms

		V _m		
V _{CC} , V	V _{mi} , V	t _{PLH} , t _{PHL}	t_{PZL} , t_{PLZ} , t_{PZH} , t_{PHZ}	V _Y , V
3.0 to 3.6	V _{CC} /2	V _{CC} /2	V _{CC} /2	0.3
4.5 to 5.5	V _{CC} /2	V _{CC} /2	V _{CC} /2	0.3

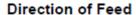
ORDERING INFORMATION

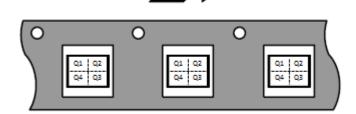
Device	Packages	Specific Device Code	Pin 1 Orientation (See below)	Shipping [†]
NLVVHC1G09DFT1G*	SC-88A	VX	Q2	3000 / Tape & Reel
NLVVHC1G09DFT2G*	SC-88A	VX	Q4	3000 / Tape & Reel
MC74VHC1G09DFT2G-L22038	SC-88A	VX	Q4	3000 / Tape & Reel
MC74VHC1G09DTT1G	TSOP-5	VX	Q4	3000 / Tape & Reel
NLV74VHC1G09DTT1G*	TSOP-5	VX	Q4	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

* NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

Pin 1 Orientation in Tape and Reel





Capable.

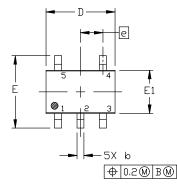
PACKAGE DIMENSIONS

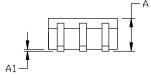
SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE M

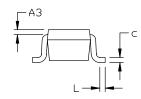
NOTES:

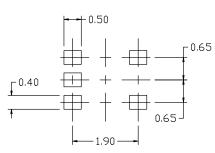
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. 419A-01 DBSDLETE, NEW STANDARD 419A-02
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS,
 OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

DIM	MILLIMETERS			
ויונע	MIN.	N□M.	MAX.	
Α	0.80	0.95	1.10	
A1			0.10	
A3	0,20 REF			
b	0.10	0.20	0.30	
C	0.10		0.25	
D	1.80	2.00	2,20	
Е	2.00	2.10	20	
E1	1.15	1,25	1.35	
е	0.65 BSC			
L	0.10	0.15	0.30	







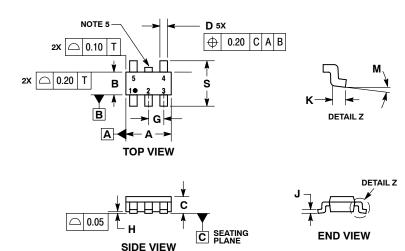


RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

PACKAGE DIMENSIONS

TSOP-5 **CASE 483 ISSUE N**

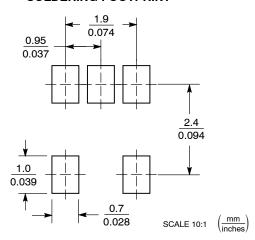


NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL DIMENSIONS A AND B DO NOT INCLUDE MOLD
- FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A.
- OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.

	MILLIMETERS				
DIM	MIN	MAX			
Α	2.85	3.15			
В	1.35	1.65			
C	0.90	1.10			
D	0.25	0.50			
G	0.95	BSC			
Н	0.01	0.10			
7	0.10	0.26			
K	0.20	0.60			
М	0 °	10°			
S	2.50	3.00			

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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